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PATENT  
81863.0030

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

YAMAGUCHI, et al.

Serial No: 10/809,251

Filed: March 25, 2004

For: Multilayer Electronic Component  
and Manufacturing Method  
Thereof

Art Unit: 2811

Examiner: Not Assigned

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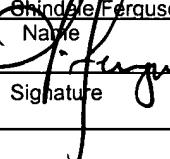
Commissioner for Patents  
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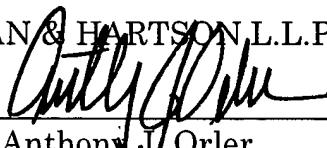
Dear Sir:

Enclosed herewith is a certified copy of Japanese patent application No. 2003-086059, which was filed March 26, 2003, and application No. 2003-120776, which was filed April 24, 2003, from which priority is claimed under 35 U.S.C. § 119 and Rule 55.

Acknowledgment of the priority document(s) is respectfully requested to ensure that the subject information appears on the printed patent.

Respectfully submitted,

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